



High power cycling capability
Low on-state and switching losses
Designed for traction and industrial applications

Phase Control Thyristor Type T133-320-28

Mean on-state current						I _{TAV}		320 A					
Repetitive peak off-state voltage						V _{DRM}		1000...2800 V					
Repetitive peak reverse voltage						V _{RRM}							
Turn-off time						t _q		250, 320, 400, 500, 630 µs					
V _{DRM} , V _{RRM} , V	1000	1100	1200	1300	1400	1500	1600	1800	2000	2200	2400	2600	2800
Voltage code	10	11	12	13	14	15	16	18	20	22	24	26	28
T _j , °C	-60...+125												

MAXIMUM ALLOWABLE RATINGS

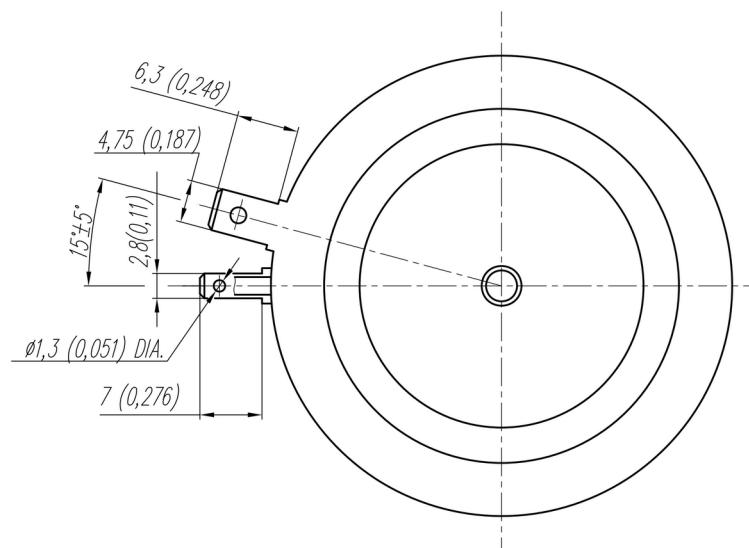
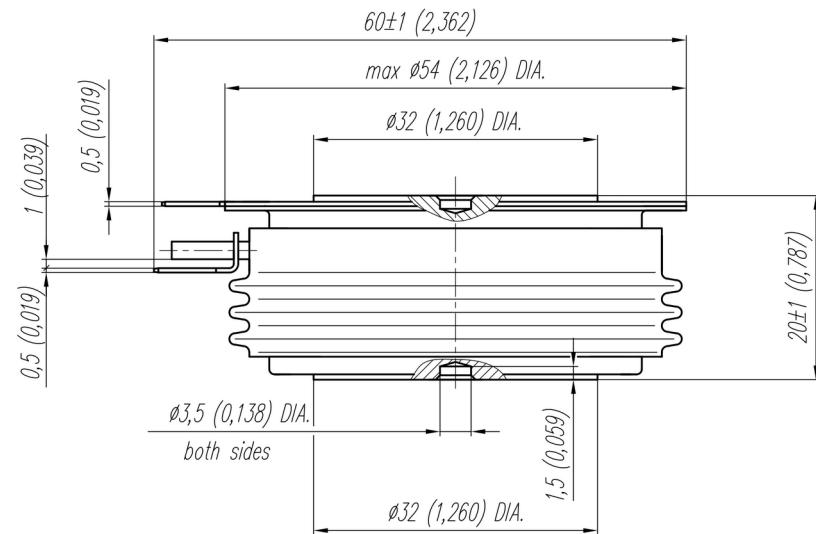
Symbols and parameters			Units	Values	Test conditions	
ON-STATE						
I _{TAV}	Maximum allowable mean on-state current		A	320 457	T _c =101 °C, Double side cooled T _c =85 °C, Double side cooled 180° half-sine wave; 50 Hz	
I _{TRMS}	RMS on-state current		A	502	T _c =101 °C, Double side cooled 180° half-sine wave; 50 Hz	
I _{TSM}	Surge on-state current		kA	6.5 7.5	T _j =T _j max T _j =25 °C	180° half-sine wave; t _p =10 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 µs; di _G /dt≥1 A/µs
				7.0 8.0	T _j =T _j max T _j =25 °C	180° half-sine wave; t _p =8.3 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 µs; di _G /dt≥1 A/µs
I ² t	Safety factor		A ² s·10 ³	210 280	T _j =T _j max T _j =25 °C	180° half-sine wave; t _p =10 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 µs; di _G /dt≥1 A/µs
				200 260	T _j =T _j max T _j =25 °C	180° half-sine wave; t _p =8.3 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 µs; di _G /dt≥1 A/µs
BLOCKING						
V _{DRM} , V _{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages		V	1000...2800	T _{j min} < T _j <T _{j max} ; 180° half-sine wave; 50 Hz; Gate open	
V _{DSM} , V _{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages		V	1100...2900	T _{j min} < T _j <T _{j max} ; 180° half-sine wave; single pulse; Gate open	
V _D , V _R	Direct off-state and Direct reverse voltages		V	0.6V _{DRM} 0.6V _{RRM}	T _j =T _j max; Gate open	

TRIGGERING				
I_{FGM}	Peak forward gate current	A	6	$T_j=T_{j \max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	3	$T_j=T_{j \max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ($f=1$ Hz)	A/ μ s	1250	$T_j=T_{j \max}$; $V_D=0.67V_{DRM}$; $I_{TM}=1300$ A; Gate pulse: $I_G=2$ A; $t_{GP}=50$ μ s; $di_G/dt \geq 2$ A/ μ s
THERMAL				
T_{stg}	Storage temperature	°C	-60...+50	
T_j	Operating junction temperature	°C	-60...+125	
MECHANICAL				
F	Mounting force	kN	9.0...11.0	
a	Acceleration	m/s ²	50	Device clamped
CHARACTERISTICS				
Symbols and parameters		Units	Values	Conditions
ON-STATE				
V_{TM}	Peak on-state voltage, max	V	1.90	$T_j=25$ °C; $I_{TM}=1005$ A
$V_{T(TO)}$	On-state threshold voltage, max	V	0.986	$T_j=T_{j \max}$;
r_T	On-state slope resistance, max	$m\Omega$	1.073	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$
I_L	Latching current, max	mA	700	$T_j=25$ °C; $V_D=12$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ μ s; $di_G/dt \geq 1$ A/ μ s
I_H	Holding current, max	mA	300	$T_j=25$ °C; $V_D=12$ V; Gate open
BLOCKING				
I_{DRM}, I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	70	$T_j=T_{j \max}$; $V_D=V_{DRM}$; $V_R=V_{RRM}$
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage ¹⁾ , min	V/ μ s	200, 320, 500, 1000, 1600, 2000, 2500	$T_j=T_{j \max}$; $V_D=0.67V_{DRM}$; Gate open
TRIGGERING				
V_{GT}	Gate trigger direct voltage, max	V	3.00 2.50 1.50	$T_j=T_{j \min}$ $T_j=25$ °C $T_j=T_{j \max}$
I_{GT}	Gate trigger direct current, max	mA	400 250 150	$T_j=T_{j \min}$ $T_j=25$ °C $T_j=T_{j \max}$
V_{GD}	Gate non-trigger direct voltage, min	V	0.60	$T_j=T_{j \max}$;
I_{GD}	Gate non-trigger direct current, min	mA	35.00	$V_D=0.67V_{DRM}$; Direct gate current
SWITCHING				
t_{gd}	Delay time, max	μ s	1.85	$T_j=25$ °C; $V_D=1500$ V; $I_{TM}=I_{TAV}$; $di/dt=200$ A/ μ s;
t_{gt}	Turn-on time, max	μ s	9.00	Gate pulse: $I_G=2$ A; $V_G=20$ V; $t_{GP}=50$ μ s; $di_G/dt=2$ A/ μ s
t_q	Turn-off time ²⁾ , max	μ s	250, 320, 400, 500, 630	$dv_D/dt=50$ V/ μ s; $T_j=T_{j \max}$; $I_{TM}=I_{TAV}$; $di_R/dt=-10$ A/ μ s; $V_R=100$ V; $V_D=0.67V_{DRM}$
Q_{rr}	Recovered charge, max	μ C	1100	$T_j=T_{j \max}$; $I_{TM}=320$ A;
t_{rr}	Reverse recovery time, max	μ s	24	$di_R/dt=-10$ A/ μ s;
I_{rr}	Reverse recovery current, max	A	92	$V_R=100$ V

THERMAL						
R_{thjc}	Thermal resistance, junction to case, max		$^{\circ}\text{C}/\text{W}$	0.040	Direct current	Double side cooled
R_{thjc-A}				0.088		Anode side cooled
R_{thjc-K}				0.072		Cathode side cooled
R_{thck}	Thermal resistance, case to heatsink, max		$^{\circ}\text{C}/\text{W}$	0.008	Direct current	

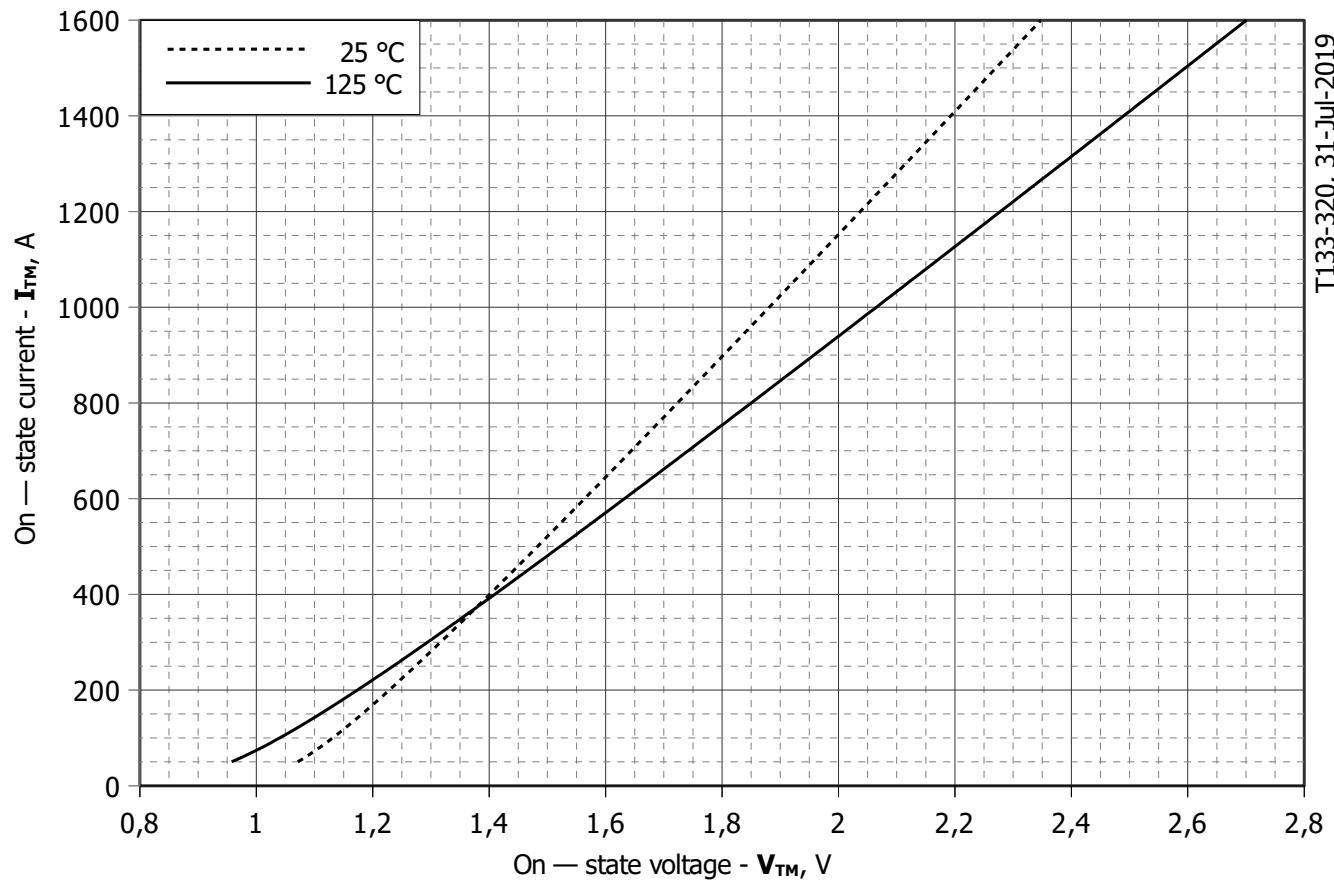
MECHANICAL						
m	Weight, max		g	185		
D_s	Surface creepage distance		mm (inch)	19.44 (0.765)		
D_a	Air strike distance		mm (inch)	12.10 (0.476)		

PART NUMBERING GUIDE							NOTES																																														
<table border="1"> <tr> <th>T</th><th>133</th><th>320</th><th>28</th><th>A2</th><th>C2</th><th>N</th></tr> <tr> <td>1</td><td>2</td><td>3</td><td>4</td><td>5</td><td>6</td><td>7</td></tr> </table>							T	133	320	28	A2	C2	N	1	2	3	4	5	6	7	<table border="1"> <tr> <td colspan="2">¹⁾ Critical rate of rise of off-state voltage</td><td colspan="2"></td><td colspan="2"></td><td colspan="2"></td></tr> <tr> <td colspan="2">Symbol of Group</td><td>P2</td><td>K2</td><td>E2</td><td>A2</td><td>T1</td><td>P1</td><td>M1</td></tr> <tr> <td colspan="2">$(dv_0/dt)_{crit}, \text{V}/\mu\text{s}$</td><td>200</td><td>320</td><td>500</td><td>1000</td><td>1600</td><td>2000</td><td>2500</td></tr> </table>							¹⁾ Critical rate of rise of off-state voltage								Symbol of Group		P2	K2	E2	A2	T1	P1	M1	$(dv_0/dt)_{crit}, \text{V}/\mu\text{s}$		200	320	500	1000	1600	2000	2500
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<ol style="list-style-type: none"> 1. Phase Control Thyristor 2. Design version 3. Mean on-state current, A 4. Voltage code 5. Critical rate of rise of off-state voltage, $\text{V}/\mu\text{s}$ 6. Turn-off time ($dv_D/dt=50 \text{ V}/\mu\text{s}$) 7. Ambient conditions: N – normal; T – tropical 							<table border="1"> <tr> <td colspan="2">²⁾ Turn-off time ($dv_D/dt=50 \text{ V}/\mu\text{s}$)</td><td colspan="2"></td><td colspan="2"></td><td colspan="2"></td></tr> <tr> <td colspan="2">Symbol of Group</td><td>M2</td><td>K2</td><td>H2</td><td>E2</td><td>C2</td><td></td></tr> <tr> <td colspan="2">$t_{q, \mu\text{s}}$</td><td>250</td><td>320</td><td>400</td><td>500</td><td>630</td><td></td></tr> </table>							²⁾ Turn-off time ($dv_D/dt=50 \text{ V}/\mu\text{s}$)								Symbol of Group		M2	K2	H2	E2	C2		$t_{q, \mu\text{s}}$		250	320	400	500	630																	
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OVERALL DIMENSIONS**Package type: T.B3**

All dimensions in millimeters (inches)

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**Fig 1 – On-state characteristics of Limit device**

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients for max curves	
	T _j = 25°C	T _j = T _{j max}
A	0.90031000	0.72388000
B	0.00075968	0.00102920
C	0.03495100	0.04718400
D	-0.00064485	-0.00044631

On-state characteristic model (see Fig. 1)

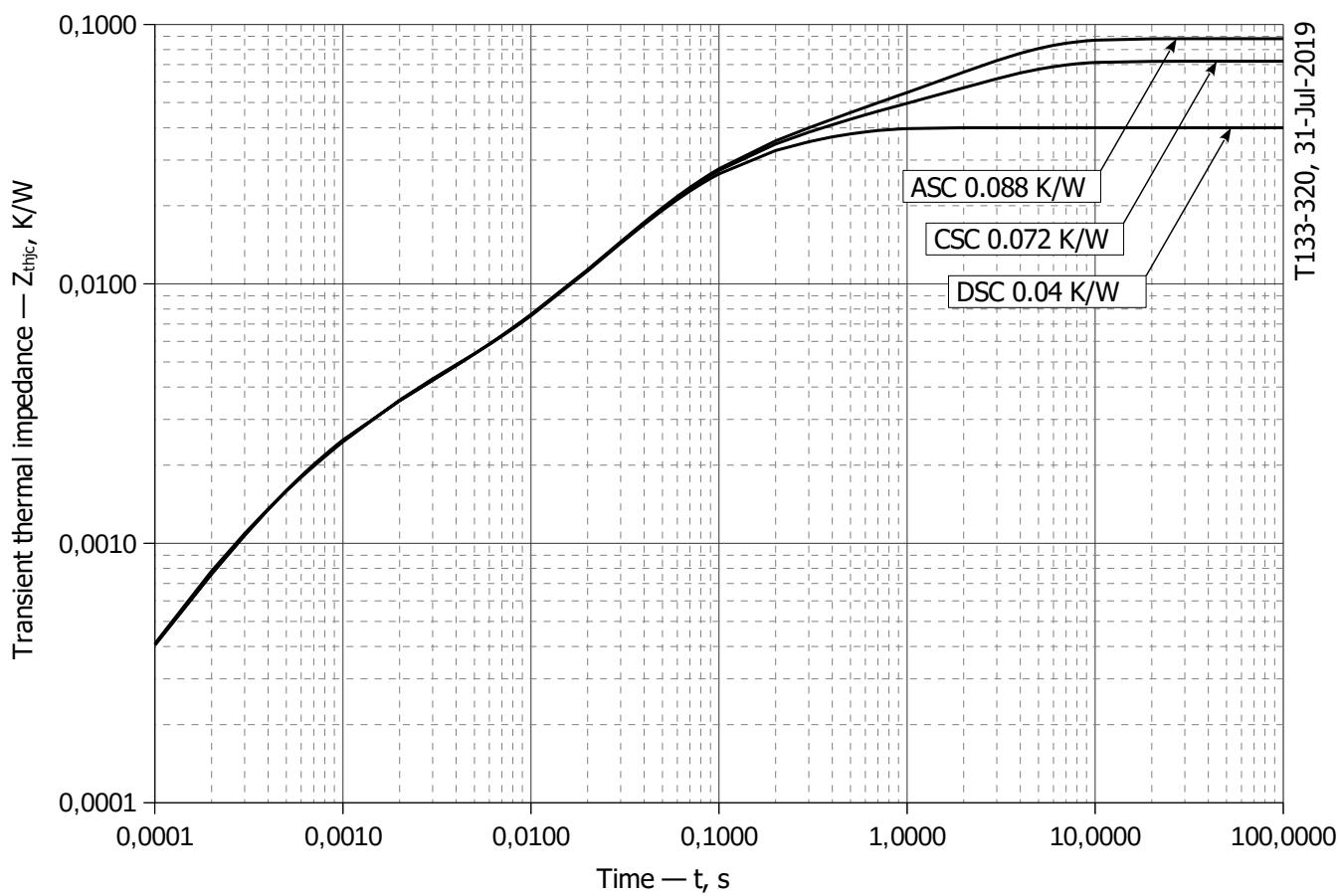


Fig 2 – Transient thermal impedance Z_{thjc} vs. time t

Analytical function for Transient thermal impedance junction to case Z_{thjc} for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left(1 - e^{-\frac{t}{\tau_i}} \right)$$

Where $i = 1$ to n , n is the number of terms in the series.

t = Duration of heating pulse in seconds.

Z_{thjc} = Thermal resistance at time t .

R_i = Amplitude of p_{th} term.

τ_i = Time constant of r_{th} term.

DC Double side cooled

i	1	2	3	4	5	6
R_i , K/W	0.01423	0.01906	0.003576	0.002535	-4.666e-005	0.0006479
τ_i , s	0.265	0.05901	0.03499	0.001252	0.000001	0.0002488

DC Anode side cooled

i	1	2	3	4	5	6
R_i , K/W	0.04804	0.001789	0.01342	0.02147	0.001374	0.001945
τ_i , s	2.651	0.4195	0.2622	0.05451	0.002585	0.0005847

DC Cathode side cooled

i	1	2	3	4	5	6
R_i , K/W	0.03216	0.01306	0.002934	0.02064	0.001493	0.001786
τ_i , s	2.647	0.2831	0.1455	0.05284	0.002255	0.0005519

Transient thermal impedance junction to case Z_{thjc} model (see Fig. 2)

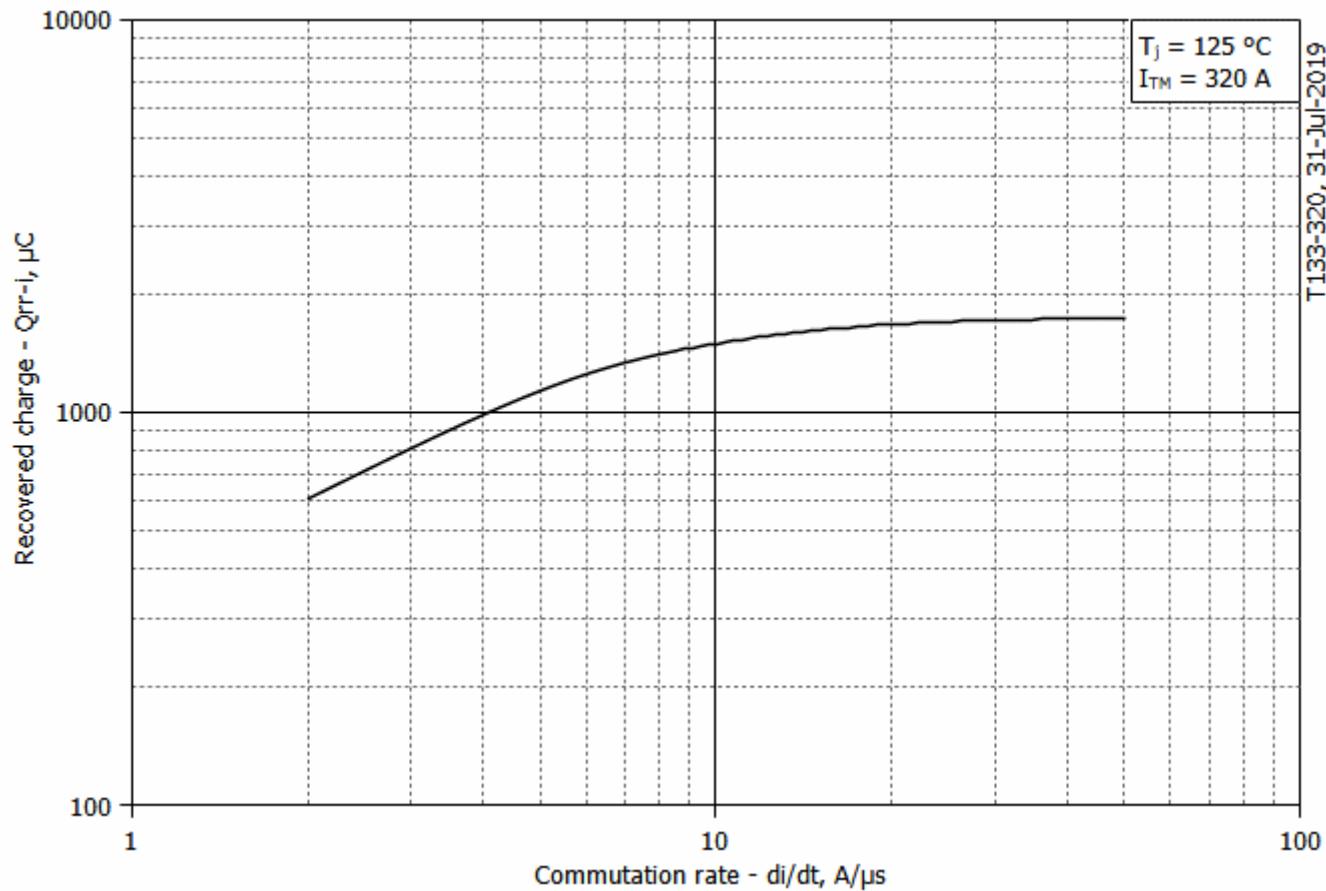


Fig 3 – Maximum recovered charge Q_{rr-i} (integral) vs. commutation rate di_R/dt

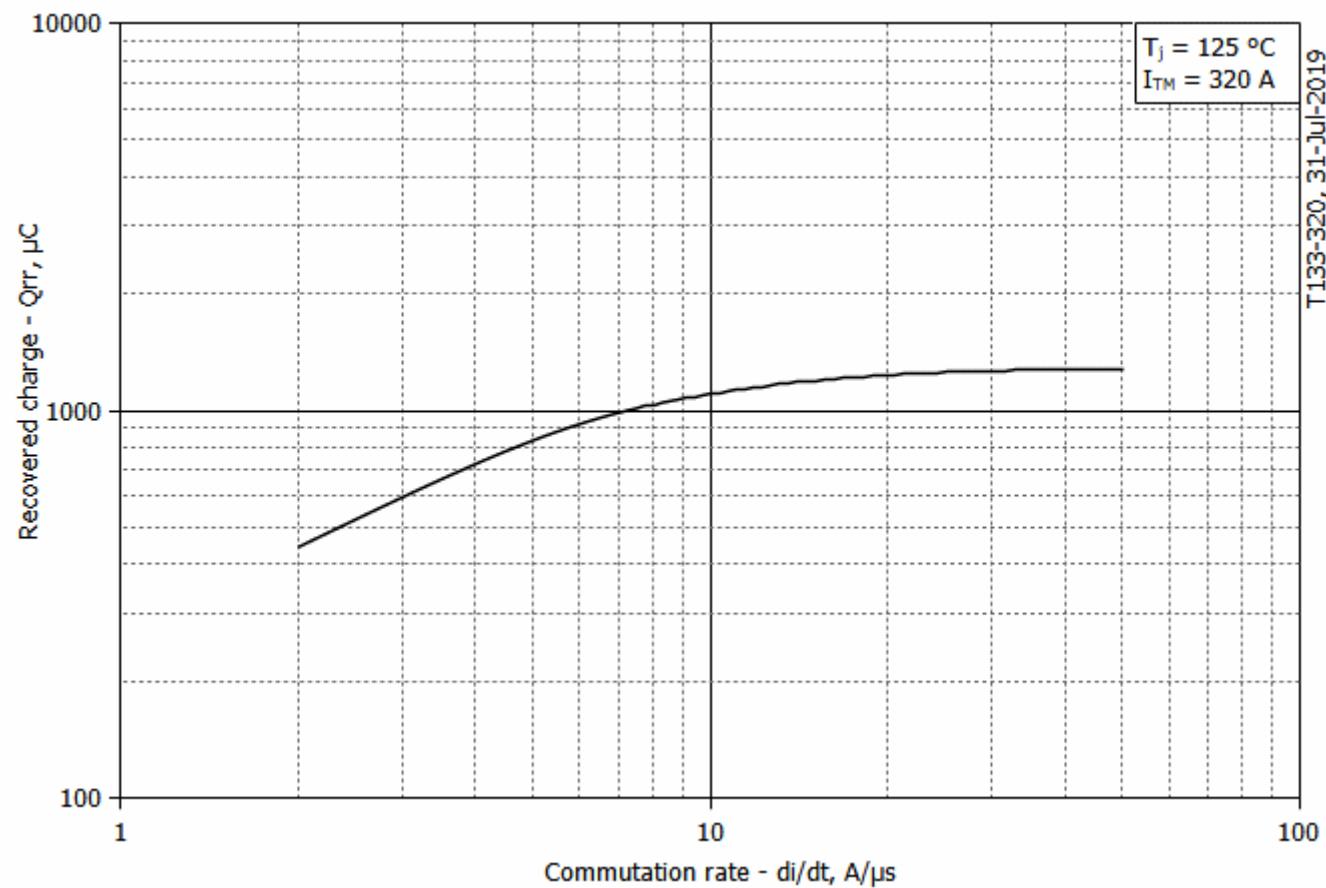


Fig 4 – Maximum recovered charge Q_{rr} vs. commutation rate di_R/dt (25% chord)

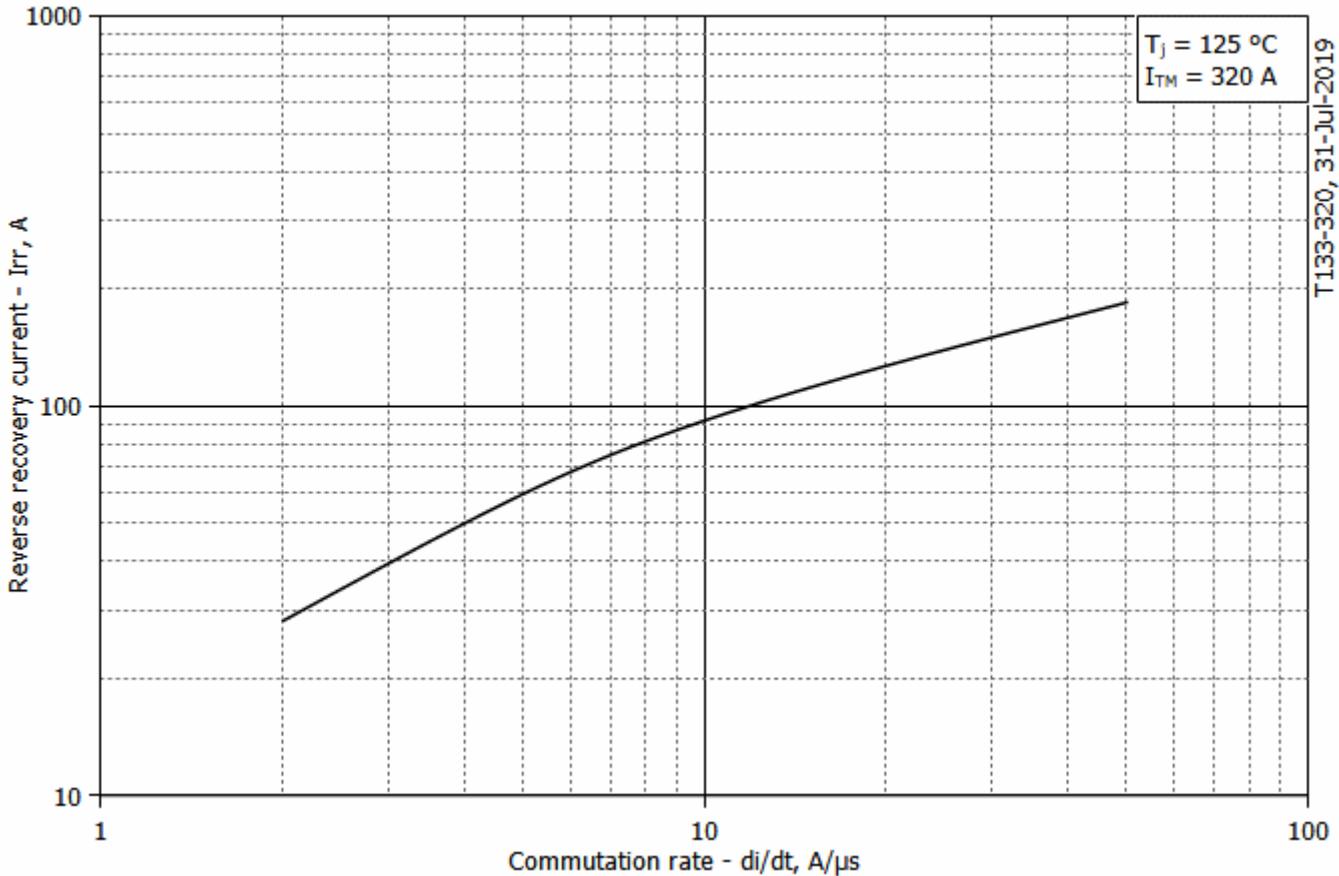


Fig 5 – Maximum reverse recovery current I_{rr} vs. commutation rate di_R/dt

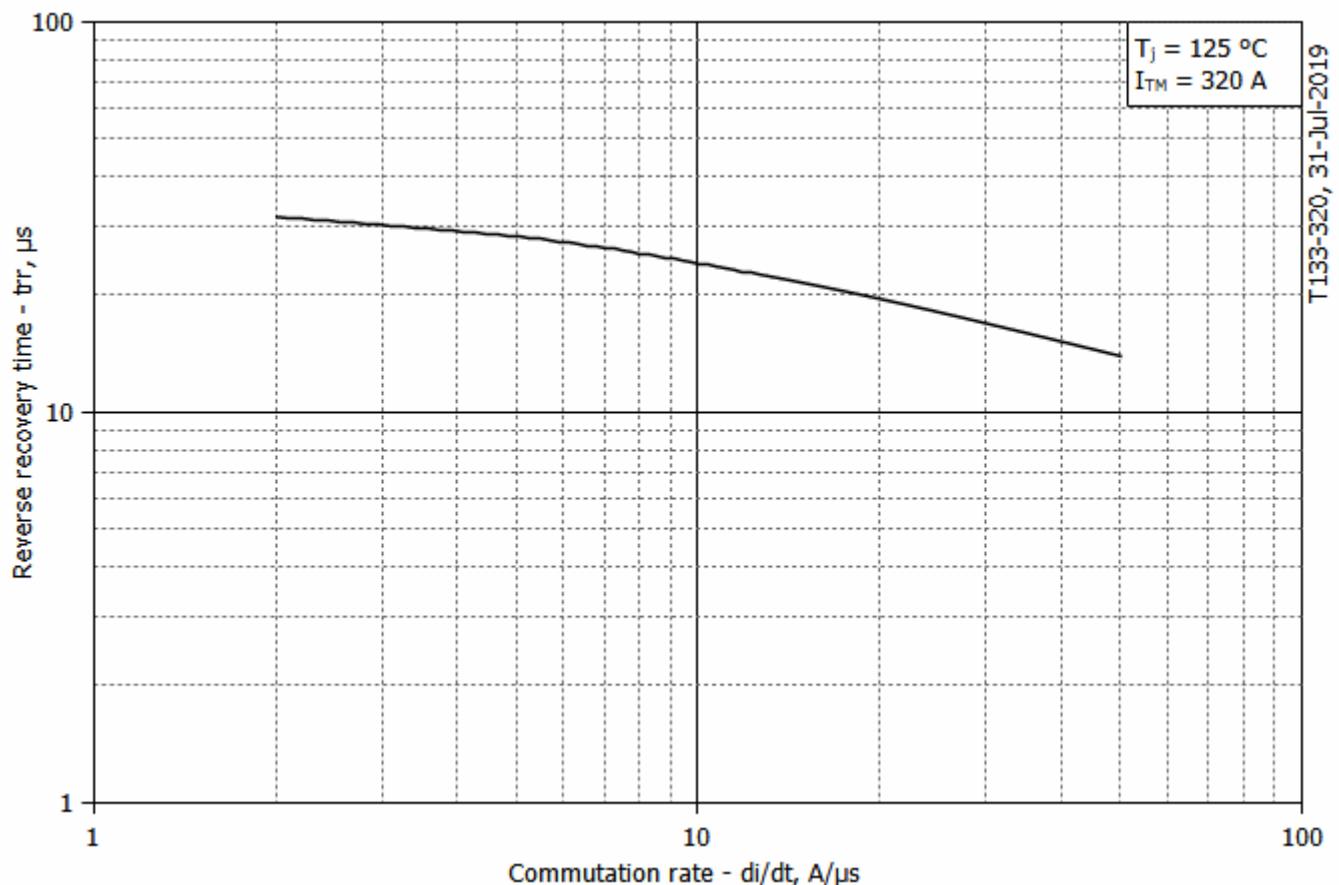


Fig 6 – Maximum recovery time t_{rr} vs. commutation rate di_R/dt (25% chord)

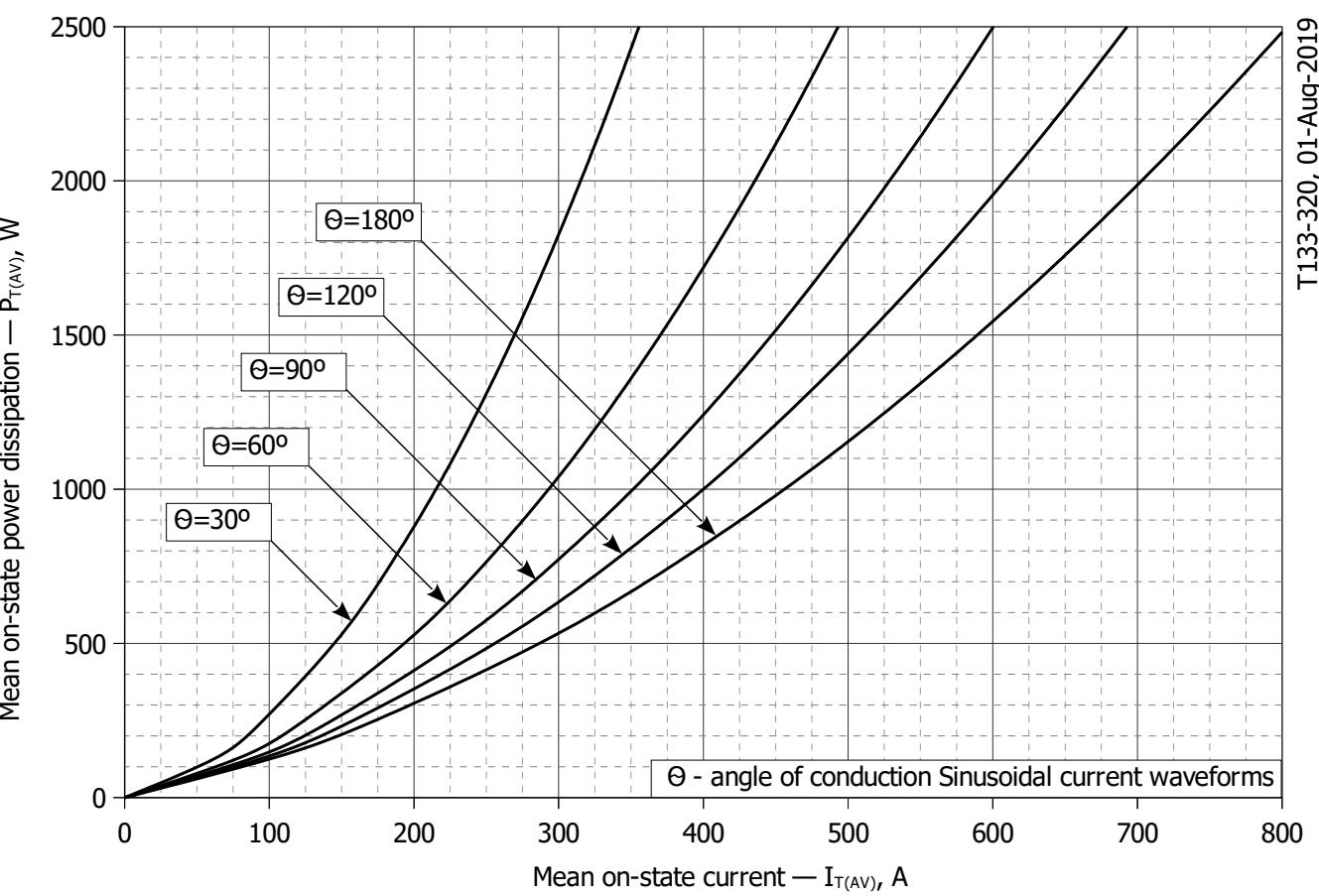


Fig. 7 - Mean on-state power dissipation P_{TAV} vs. mean on-state current I_{TAV} for sinusoidal current waveforms at different conduction angles ($f=50\text{Hz}$, DSC)

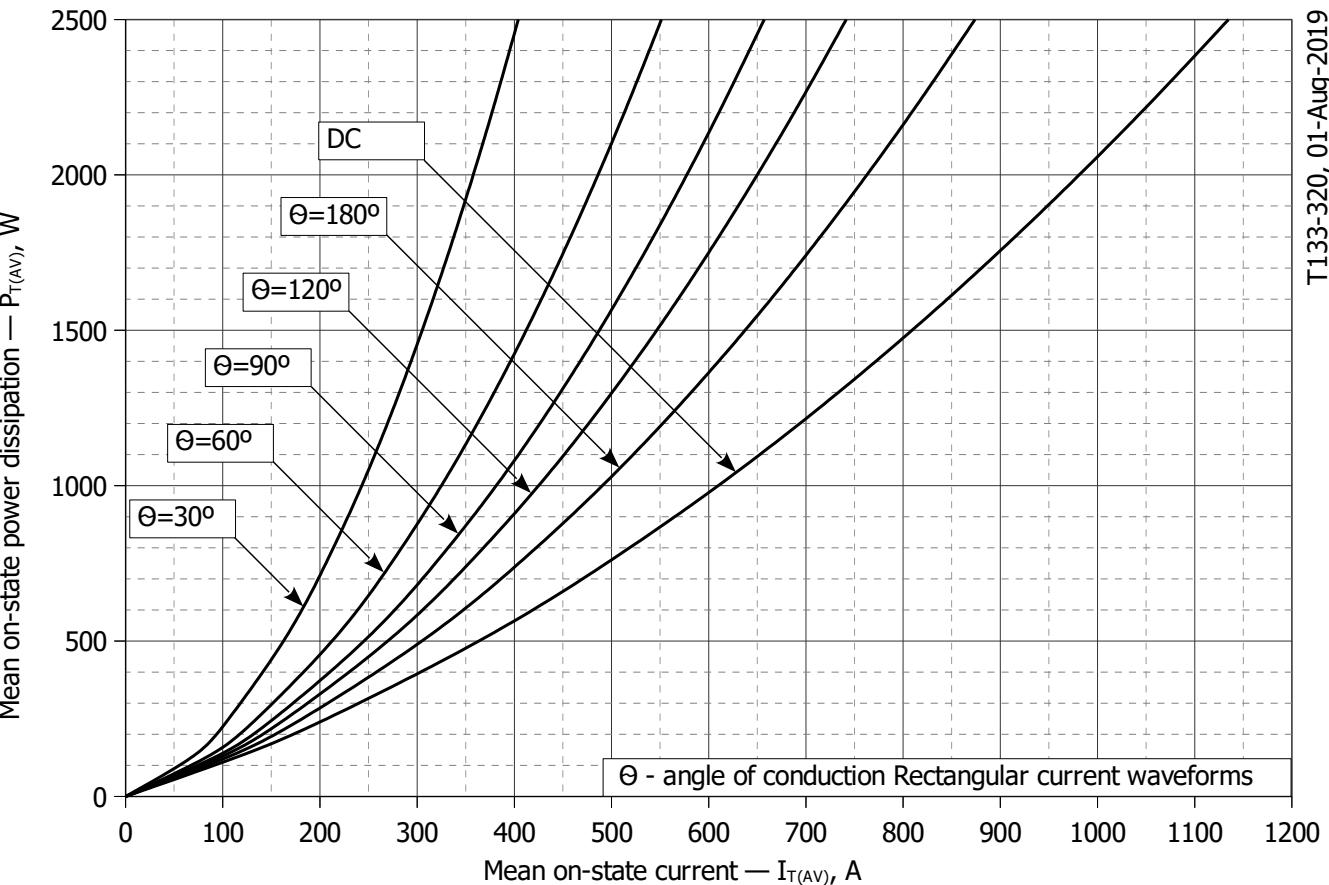


Fig. 8 – Mean on-state power dissipation P_{TAV} vs. mean on-state current I_{TAV} for rectangular current waveforms at different conduction angles and for DC ($f=50\text{Hz}$, DSC)

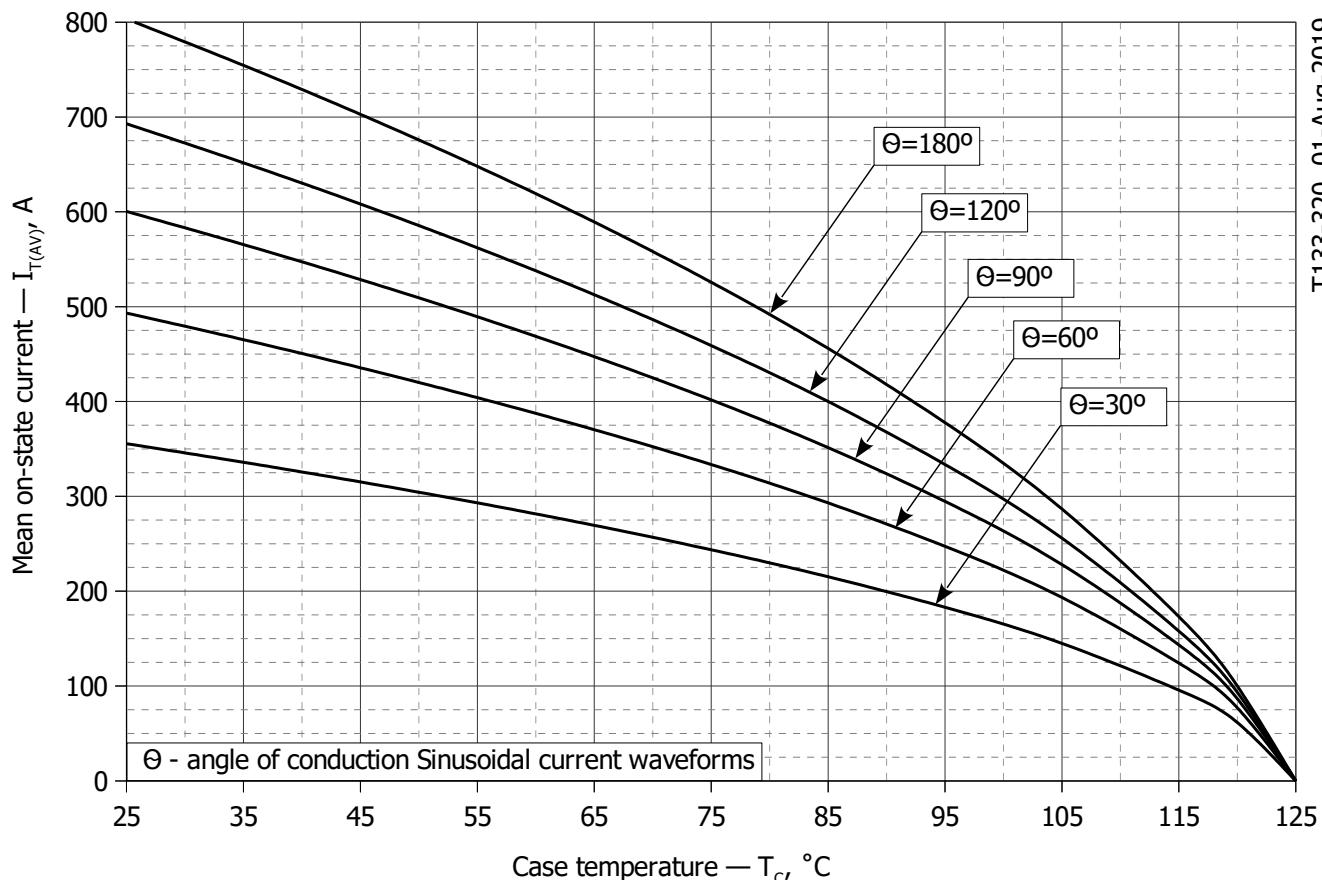


Fig. 9 – Mean on-state current I_{TAV} vs. case temperature T_c for sinusoidal current waveforms at different conduction angles (f=50Hz, DSC)

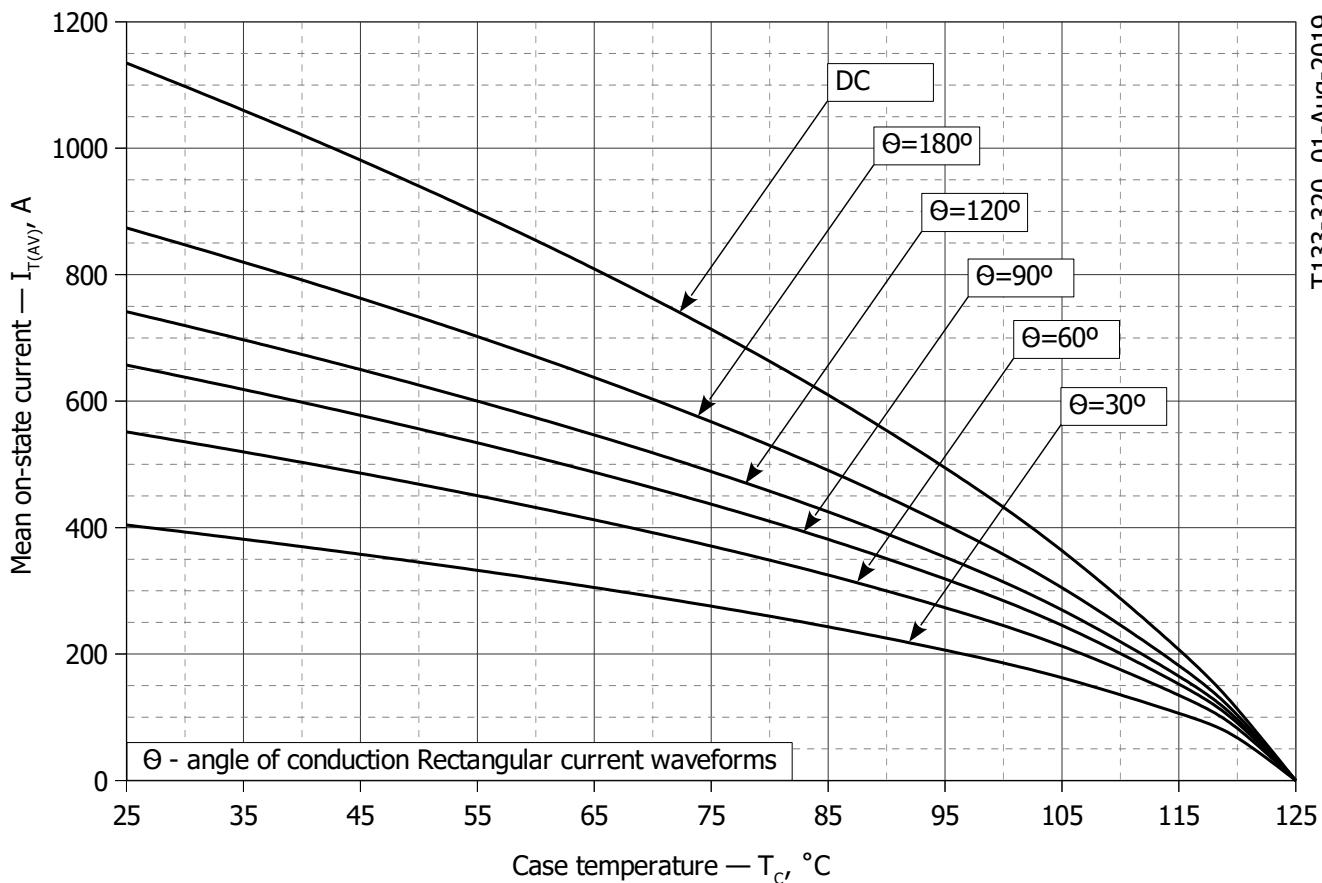


Fig. 10 - Mean on-state current I_{TAV} vs. case temperature T_c for rectangular current waveforms at different conduction angles and for DC (f=50Hz, DSC)

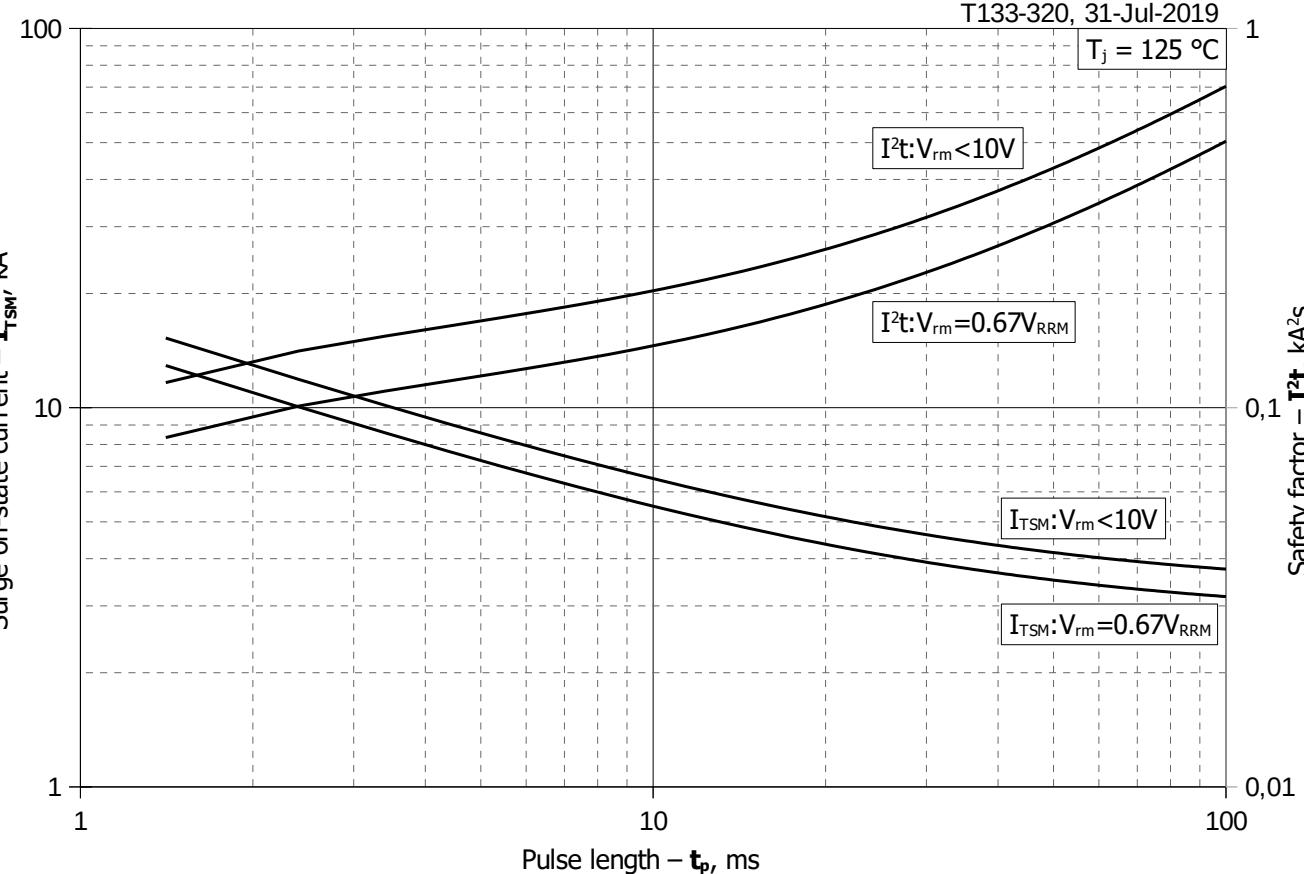


Fig. 11 – Maximum surge on-state current I_{TSM} and safety factor I^2t vs. pulse length t_p

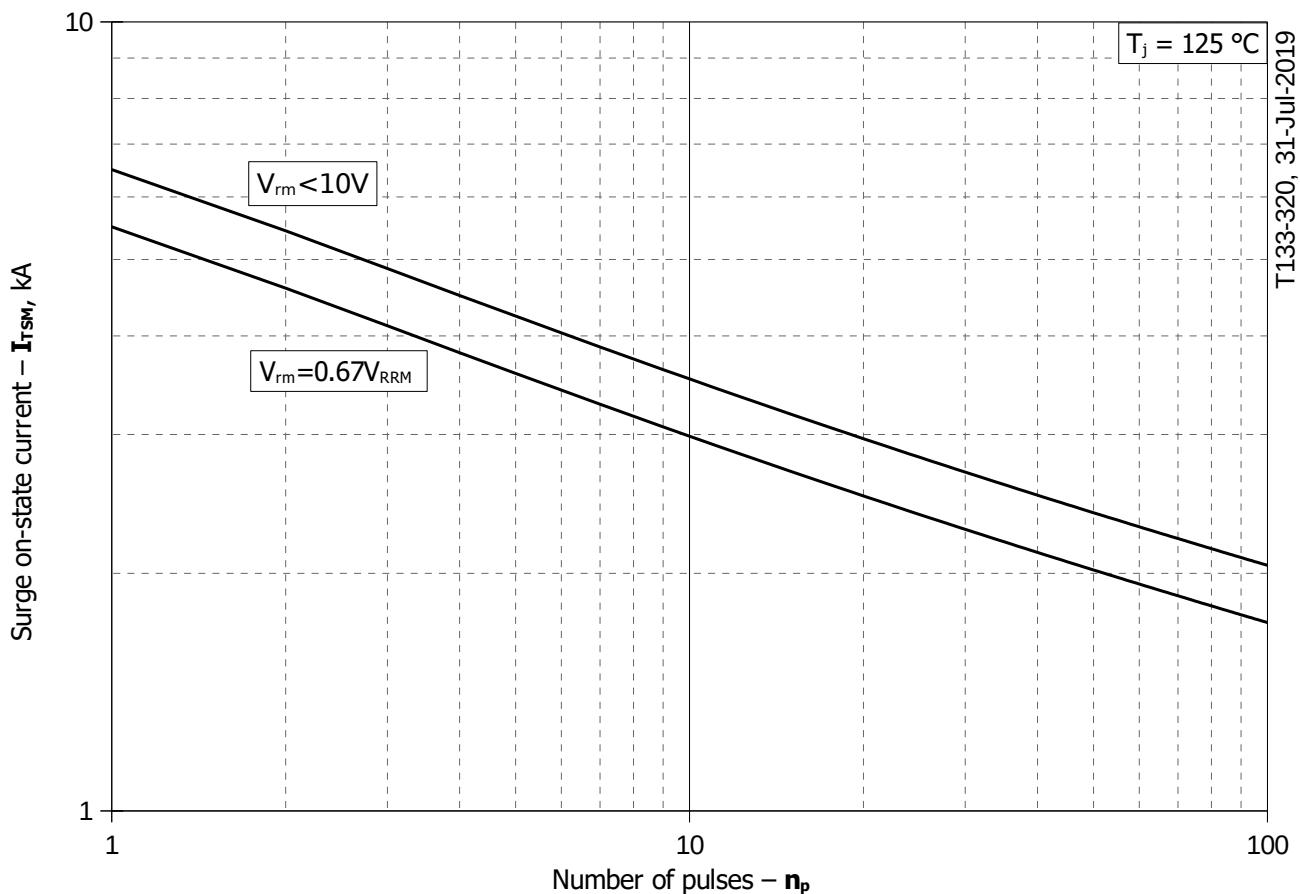


Fig. 12 - Maximum surge on-state current I_{TSM} vs. number of pulses n_p